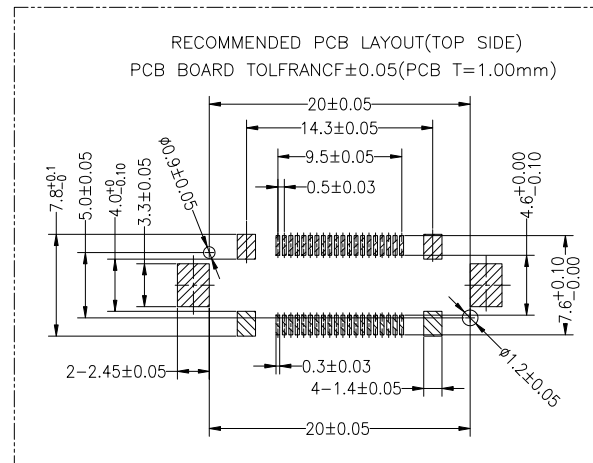
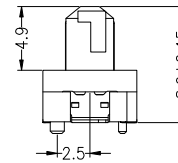


公、母座-合高图

Ass'y High(H)	Plastic High	
	Male (H1)	Female (H2)
8.00	6.90	6.00
10.00	8.90	6.00



SPECIFICATIONS PERFORMANCE

Current Rating (信号端子): 0.5A
Current Rating (电源端子): 5A
Contact Resistance: 80mΩ Max
Insulation Resistance: 500MΩ Min
Withstand Volt: 200V AC/minute
Operating Temperature: -40°C to +105°C

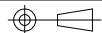
Material

Contact: Phosphor Bronze, 3u" MIN Gold Plated In Contact Area,
Gold Flash Plated In Solder Area,
50u"~240u" Nickel Underplated Over all.
Ground: Brass, 80u" Min Matte Tin Plated Over
50u" Min Nickel Underplated Over all.
Housing: LCP Black, UL94V0
Max. Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Ordering Information

HC-PBB23L - NDP - 0.5V * - ** - 01

No. of Pins	Nature DP=Male	PITCH	High (H±H)	Contact Plating
30~120Pin	25%	0.5V±0.5mm	8=8.0mm	02:3u" Gold
30~30Pin			10=10.0mm	S0:1u" Gold/Tin
50~50Pin				S1:3u" Gold/Tin
				S2:5u" Gold/Tin
				S3:10u" Gold/Tin
				S4:15u" Gold/Tin
				S5:30u" Gold/Tin

			GENERAL TOLERANCE	制 图 DRAWING	 深圳市华灿天禄电子有限公司 ShenzhenhuacantianluELECTRONICS CO., LTD				
			DIM TOL	审 核 CHECK					
			X.X ±0.30	批 准 APPROVAL	产品名称 TITLE	BTB 0.5 高频大电流 浮动式 H8.9 贴片公座 带柱	版 本 REV.	A	
			X.XX ±0.20	比 例 SCALE	产品料号 PART NO.	HC-PBB23L-40DP-0.5VX-XX-01	单 位 UNITS	mm	
1	初版发行		X.XXX ±0.10						
序号 No.	变更内容 MODIFY CONTENT	日 期 MODIFY DATE	Angle ±3.0°	投 影 Projection		材 料 MATERIAL	页 次 SHEET	1/1	